

EM MICROELECTRONIC

A COMPANY OF THE **SWATCH GROUP**

FACT SHEET | EM4423

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www.emmicroelectronic.com



Transponder IC

General Description

EM4423 corresponds to the latest generation of EM Microelectronic contactless devices, bringing innovative features to the NFC and UHF EPC worlds. The chip combines two functionalities on one single die, the UHF EPC technology used for long range application purposes and the NFC used to exchange data in a proximity range. Both protocols may share a common unique ID.

Targeted applications and market segments include retail, product authentication or smart NFC posters.

A tag or label based on the EM4423 provides multiple benefits and usages via the UHF communication interface like stock inventory, product returns, and consumer privacy. The same tag or label also enables new marketing services like product information or loyalty programs using an NFC enabled smartphone.

The chip is a dual frequency device supporting ISO/IEC14443 Type A, NFC Forum Type 2 specifications, ISO/IEC18000-63 and EPC Gen2 V2. On top of that, other features have been added to provide chip privacy. For the NFC interface, the smart counter increments its value each time the NFC message has been read by the end-user.

Each chip is manufactured with a 96-bit unalterable unique identifier (UID) to ensure full traceability. The same UID number is used by both RF protocols. During an ISO/IEC14443 anti-collision procedure, the 7 bytes which are part of the 96-bit are sent back by the transponder IC.

The EM4423 offers two non-volatile memories which are accessible by both RF air interfaces. The two memories are segmented to implement multiple applications. Each chip is delivered with a preprogrammed 96-bit EPC encoding supporting Multi-vendor Chipbased Serialization (MCS).

EM4423 supports the optional BlockWrite command, enabling the fast encoding of a 96-bit EPC. EM4423 also supports the optional Untraceable command to hide portions of memory of the tag or label.

Applications

I NFC

- · Product Information
- · Wifi, Bluetooth pairings
- · Smart posters, Advertisings
- · Coupons, loyalty programs

I EPO

- · Supply chain management
- Tracking and tracing
- · Container identification
- · Asset control

Features

I Dual Frequency 1-step inlay manufacturing

NFC Type 2 & EPC GEN2V2

- I Common unique ID
- I Shared memory
- I Minimum 100k write cycles endurance
- I Minimum 10 years data retention

DUAL Frequency

- I Extended temperature range (-40°C to +85°C)
- I Sawn wafers, 3/6-mil thickness, gold bumps

I HF/NFC Interface

- · ISO/IEC 14443A -3 compliant tag
- \cdot A full compliance to the NFC Forum Tag 2 Type technical specification
- · Enables NDEF data structure configurations
- · Communication baud rates at 106kbps
- \cdot 7 Bytes unique ID number using same serialization as UHF interface
- · 1920-bit user's memory
- · Anti-tearing support for NFC capability container (CC) and Static/Dynamic lock bytes
- · NFC Memory locking mechanism per block/page
- · ACCESS counter increased at first reading
- · Optional UHF memory mapping
- · Optional read-only locking function
- · Optional limit of unsuccessful LOGINs
- · 17pF or 50pF NFC on-chip resonant capacitor

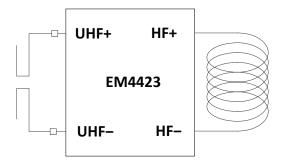
UHF/EPC Interface

- · ISO/IEC 18000-63 compliant
- · EPC Gen2 V2 compliant
- · Supports multi-vendor chip-based serialization
- · 128-bit or 224-bit UII/EPC
- 96-bit TID number using same serialization as HF interface
- · 160-bit or 64-bit USER memory bank
- · 32-bit access and user passwords
- -19 dBm typical IC read sensitivity-15 dBm typical IC write sensitivity
- · Fast writing using the BlockWrite command
- · BlockPermalock of USER memory
- · Optional HF memory mapping
- · The ACCESS counter status readable

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Typical Operating Application



Standard Versions & Samples

The versions below are considered standard and should be readily available. For other versions or other delivery form, please contact EM Microelectronic-Marin S.A. For samples, please order exclusively from the standard versions.

Part Number	UHF Memory Format	HF Options	Package / Die Form	Delivery Form
EM4423V121WS3U	Short EPC	50 pF Modem Mode disabled	Sawn wafer / Gold bumped +PI - thickness of 3 mils	Wafer on frame
EM4423V222WS3U	Large EPC	50 pF Modem Mode enabled	Sawn wafer / Gold bumped +PI - thickness of 3 mils	Wafer on frame
EM4423V212WS3U	Large EPC	50 pF Modem Mode enabled	Sawn wafer / Gold bumped +PI - thickness of 3 mils	Wafer on frame